

# DECLARATION AND POWER OF ATTORNEY

As a below named inventor, I declare that:

My residence, post office address and citizenship are as stated below next to my name; I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural inventors are named below) of the subject matter which is claimed and for which a patent is sought on the invention entitled: **TERMINATION STRUCTURE OF DMOS DEVICE** the specification of which  X  is attached hereto or   was filed on   as Application No.   and was amended on   (if applicable).

I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above. I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, Section 1.56. I claim foreign priority benefits under Title 35, United States Code, Section 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed.

## Prior Foreign Application(s)

Country	Application No.	Date of Filing	Priority Claimed Under 35 USC 119
R.O.C.	092107170	03/28/2003	Yes

**POWER OF ATTORNEY:** As a named inventor, I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and transact all business in the Patent and Trademark Office connected therewith.

Chun-Pok Leung, Reg. No. 41,405

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Full Name of Inventor 4:	Last Name: <b>HSIEH</b>	First Name: <b>HSING-HUANG</b>	Middle Name or Initial:	
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I further declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Signature of Inventor 1  <i>Chiao-Shun Chuang</i> <hr/> Chiao-Shun Chuang Date 2003/12/24	Signature of Inventor 2  <i>Chien-Ping Chang</i> <hr/> Chien-Ping Chang Date 2003/12/25	Signature of Inventor 3  <i>Mao-Song Tseng</i> <hr/> Mao-Song Tseng Date 2003/12/25
Signature of Inventor 4  <i>Hsing-Huang Hsieh</i> <hr/> Hsing-Huang Hsieh Date 2003/12/23		